

## TLx84xB 高性能電流モード PWM コントローラ

### 1 特長

- 低いスタートアップ電流 (0.5mA 未満)
- トリムされた発振器放電電流
- 最大 500kHz の電流モード動作
- 自動フィードフォワード補償
- ラッチ PWM によるサイクルごとの電流制限
- 内部トリムされたリファレンス電圧、低電圧誤動作防止付き
- ヒステリシス付きの大電流トータムポール出力低電圧誤動作防止
- ダブルパルス抑制

### 2 アプリケーション

- あらゆる極性のスイッチングレギュレータ
- トランス結合型 DC/DC コンバータ

### 3 概要

TL284xB および TL384xB シリーズの制御 IC には、オフラインまたは DC-DC 固定周波数の電流モード制御方式を最小限の外付け部品で実装するために必要な機能が搭載されています。低電圧誤動作防止 (UVLO) および高精度リファレンス電圧を内蔵し、エラーアンプ入力における精度を向上するようにトリムされています。それ以外にも、ラッチ動作を保証するロジック、パルス幅変調 (PWM) コンパレータ (電流制限制御の機能も兼ねています)、大きなピーク電流をソースまたはシンクするように設計されたトータムポール出力段が内蔵されています。出力段は N チャネル MOSFET の駆動に適しており、オフ状態では Low になります。

TL284xB および TL384xB シリーズは、標準の TL284x および TL384x とピン互換であり、以下の点が改善されています。スタートアップ電流は 0.5mA (最大値) に規定され、発振器放電電流は 8.3mA (標準値) にトリムされています。また、低電圧誤動作防止状態では、10mA をシンクしているときの出力の飽和電圧は 1.2V です ( $V_{CC} = 5V$ )。

これらのシリーズに属する製品間の主な違いは、UVLO スレッシュホールドおよび最大デューティサイクル範囲です。UVLO スレッシュホールドの標準値は、TLx842B および TLx844B デバイスでは 16V (オン) と 10V (オフ) であり、オフラインのアプリケーションに理想的です。TLx843B および TLx845B デバイスについては、対応するスレッシュホールドの標準値は、8.4V (オン) と 7.6V (オフ) です。TLx842B および TLx843B デバイスは、100% に近いデューティサイクルで動作可能です。TLx844B および TLx845B には、内部にトグルフリップフロップが追加されているため、

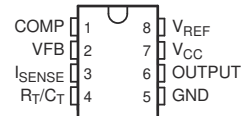
デューティサイクルの範囲は 0%~50% となります。この結果、2 クロックサイクルごとに出力がオフになります。TL284xB シリーズのデバイスは -40°C~85°C、TL384xB シリーズのデバイスは 0°C~70°C での動作が規定されています。

#### パッケージ情報

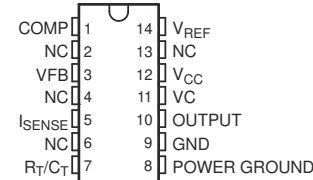
| 部品番号   | パッケージ(1)     | パッケージサイズ(2)     |
|--------|--------------|-----------------|
| TLx84x | D (SOIC, 8)  | 4.90mm × 6.00mm |
|        | D (SOIC, 14) | 8.65mm × 6.00mm |
|        | P (PDIP, 8)  | 9.81mm × 9.43mm |

- (1) 利用可能なすべてのパッケージについては、データシートの末尾にある注文情報を参照してください。
- (2) パッケージサイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。

D (SOIC) OR P (PDIP) PACKAGE  
(TOP VIEW)



D (SOIC) PACKAGE  
(TOP VIEW)



NC – No internal connection

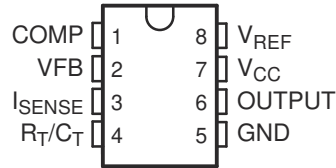


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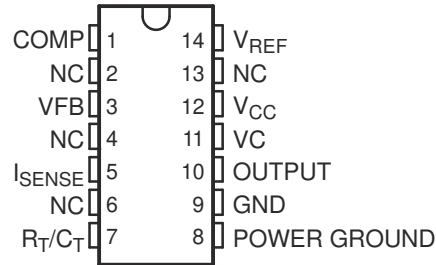
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## 4 Pin Configuration and Functions

**D (SOIC) OR P (PDIP) PACKAGE  
(TOP VIEW)**



**D (SOIC) PACKAGE  
(TOP VIEW)**



NC – No internal connection

| NAME         | PIN         |                 | Type <sup>(1)</sup> | DESCRIPTION                         |
|--------------|-------------|-----------------|---------------------|-------------------------------------|
|              | D (14 pins) | D or P (8 pins) |                     |                                     |
| COMP         | 1           | 1               | I/O                 | Error amplifier compensation pin    |
| GND          | 9           | 5               | -                   | Device power supply ground terminal |
| ISENSE       | 5           | 3               | I                   | Current sense comparator input      |
| NC           | 2, 4, 6, 13 | -               | -                   | Do not connect                      |
| OUTPUT       | 10          | 6               | O                   | PWM Output                          |
| POWER GROUND | 8           | -               | -                   | Output PWM ground terminal          |
| REF          | 14          | 8               | O                   | Oscillator voltage reference        |
| RT/CT        | 7           | 4               | I/O                 | Oscillator RC input                 |
| VC           | 11          | -               | -                   | Output PWM positive voltage supply  |
| VCC          | 12          | 7               | -                   | Device positive voltage supply      |
| VFB          | 3           | 2               | I                   | Error amplifier input               |

(1) I = Input; O = Output; I/O = Input or Output

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup> <sup>(2)</sup>

|                      |                                     |                            | MIN  | MAX           | UNIT |
|----------------------|-------------------------------------|----------------------------|------|---------------|------|
| V <sub>CC</sub>      | Supply voltage                      | Low impedance source       |      | 30            | V    |
|                      |                                     | I <sub>CC</sub> < 30 mA    |      | Self limiting |      |
| V <sub>I</sub>       | Analog input voltage range          | VFB and I <sub>SENSE</sub> | -0.3 | 6.3           | V    |
| I <sub>CC</sub>      | Supply current                      |                            |      | 30            | mA   |
| I <sub>O</sub>       | Output current                      |                            |      | ±1            | A    |
| I <sub>O(sink)</sub> | Error amplifier output sink current |                            |      | 10            | mA   |
|                      | Output energy                       | Capacitive load            |      | 5             | μJ   |
| T <sub>J</sub>       | Virtual junction temperature        |                            |      | 150           | °C   |
| T <sub>stg</sub>     | Storage temperature range           |                            | -65  | 150           | °C   |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) All voltages are with respect to the device GND terminal.

### 5.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ±3000 | V    |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±2000 |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

|                     |                                    |                                | MIN  | NOM | MAX | UNIT |
|---------------------|------------------------------------|--------------------------------|------|-----|-----|------|
| V <sub>CC</sub>     | Supply voltage                     | V <sub>CC</sub>                |      |     | 30  | V    |
|                     |                                    | VC <sup>(1)</sup>              |      |     | 30  |      |
| V <sub>I</sub>      | Input voltage                      | R <sub>T</sub> /C <sub>T</sub> | 0    |     | 5.5 | V    |
|                     |                                    | VFB and I <sub>SENSE</sub>     | 0    |     | 5.5 |      |
| V <sub>O</sub>      | Output voltage                     | OUTPUT                         | 0    |     | 30  | V    |
|                     |                                    | POWER GROUND <sup>(1)</sup>    | -0.1 |     | 1   |      |
| I <sub>CC</sub>     | Supply current, externally limited |                                |      |     | 25  | mA   |
| I <sub>O</sub>      | Average output current             |                                |      |     | 200 | mA   |
| I <sub>O(ref)</sub> | Reference output current           |                                |      |     | -20 | mA   |
| f <sub>osc</sub>    | Oscillator frequency               |                                |      | 100 | 500 | kHz  |
| T <sub>J</sub>      | Operating free-air temperature     | TL284xB                        | -40  |     | 85  | °C   |
|                     |                                    | TL384xB                        | 0    |     | 70  |      |

- (1) The recommended voltages for VC and POWER GROUND apply only to the 14-pin D package.

## 5.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                           | TLx84xB |        |         | UNIT |
|---|---------|--------|---------|------|
|   | D       | P      | D       |      |
|   | 8 PINS  | 8 PINS | 14 PINS |      |
| R <sub>θJA</sub> Junction-to-ambient thermal resistance | 117.4   | 74.1   | 87.9    | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.

## 5.5 Reference Section Electrical Characteristics

V<sub>CC</sub> = 15 V<sup>(1)</sup>, R<sub>T</sub> = 10 kΩ, C<sub>T</sub> = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER   | TEST CONDITIONS  | TL284xB |                    |      | TL384xB |                    |      | UNIT  |
|---|--|---------|--------------------|------|---------|--------------------|------|-------|
|   |  | MIN     | TYP <sup>(2)</sup> | MAX  | MIN     | TYP <sup>(2)</sup> | MAX  |       |
| Output voltage                                    | I <sub>O</sub> = 1 mA, T <sub>J</sub> = 25°C                   | 4.95    | 5                  | 5.05 | 4.9     | 5                  | 5.1  | V     |
| Line regulation                                   | V <sub>CC</sub> = 12 V to 25 V                                 |         | 6                  | 20   |         | 6                  | 20   | mV    |
| Load regulation                                   | I <sub>O</sub> = 1 mA to 20 mA                                 |         | 6                  | 25   |         | 6                  | 25   | mV    |
| Average temperature coefficient of output voltage |  |         | 0.2                | 0.4  |         | 0.2                | 0.4  | mV/°C |
| Output voltage, worst-case variation              | V <sub>CC</sub> = 12 V to 25 V, I <sub>O</sub> = 1 mA to 20 mA | 4.9     |                    | 5.1  | 4.82    |                    | 5.18 | V     |
| Output noise voltage                              | f = 10 Hz to 10 kHz, T <sub>J</sub> = 25°C                     |         | 50                 |      |         | 50                 |      | μV    |
| Output-voltage long-term drift                    | After 1000 h at T <sub>J</sub> = 25°C                          |         | 5                  | 25   |         | 5                  | 25   | mV    |
| Short-circuit output current                      |  | -30     | -100               | -180 | -30     | -100               | -180 | mA    |

(1) Adjust V<sub>CC</sub> above the start threshold before setting V<sub>CC</sub> to 15 V.

(2) All typical values are at T<sub>J</sub> = 25°C.

## 5.6 Oscillator Section Electrical Characteristics

V<sub>CC</sub> = 15 V<sup>(1)</sup>, R<sub>T</sub> = 10 kΩ, C<sub>T</sub> = 3.3 nF, over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER             | TEST CONDITIONS   | TL284xB |                    |     | TL384xB |                    |     | UNIT |
|-----------------------|---|---------|--------------------|-----|---------|--------------------|-----|------|
|                       |   | MIN     | TYP <sup>(2)</sup> | MAX | MIN     | TYP <sup>(2)</sup> | MAX |      |
| Initial accuracy      | T <sub>J</sub> = 25°C   | 47      | 52                 | 57  | 47      | 52                 | 57  | kHz  |
|                       | T <sub>A</sub> = T <sub>low</sub> to T <sub>high</sub>                |         |                    | 60  |         |                    | 60  |      |
|                       | T <sub>J</sub> = 25°C, R <sub>T</sub> = 6.2 kΩ, C <sub>T</sub> = 1 nF | 225     | 250                | 275 | 225     | 250                | 275 |      |
| Voltage stability     | V <sub>CC</sub> = 12 V to 25 V  |         | 0.2                | 1   |         | 0.2                | 1   | %    |
| Temperature stability |   |         | 5                  |     |         | 5                  |     | %    |
| Amplitude             | Peak to peak  |         | 1.7                |     |         | 1.7                |     | V    |
| Discharge current     | T <sub>J</sub> = 25°C, R <sub>T</sub> /C <sub>T</sub> = 2 V           | 7.8     | 8.3                | 8.8 | 7.8     | 8.3                | 8.8 | mA   |
|                       | R <sub>T</sub> /C <sub>T</sub> = 2 V                                  |         | 7.5                | 8.8 |         | 7.6                | 8.8 |      |

(1) Adjust V<sub>CC</sub> above the start threshold before setting it to 15 V.

(2) All typical values are at T<sub>J</sub> = 25°C.

(3) Output frequency equals oscillator frequency for the TL3842B and TL3843B. Output frequency is one-half the oscillator frequency for the TL3844B and TL3845B.

## 5.7 Error-Amplifier Section Electrical Characteristics

$V_{CC} = 15\text{ V}^{(1)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                       | TEST CONDITIONS                                  | TL284xB |                    |      | TL384xB |                    |      | UNIT          |
|---------------------------------|--|---------|--------------------|------|---------|--------------------|------|---------------|
|                                 |  | MIN     | TYP <sup>(2)</sup> | MAX  | MIN     | TYP <sup>(2)</sup> | MAX  |               |
| Feedback input voltage          | COMP = 2.5 V                                     | 2.45    | 2.5                | 2.55 | 2.42    | 2.5                | 2.58 | V             |
| Input bias current              |  |         | -0.3               | -1   |         | -0.3               | -2   | $\mu\text{A}$ |
| Open-loop voltage amplification | $V_O = 2\text{ V to }4\text{ V}$                 | 65      | 90                 |      | 65      | 90                 |      | dB            |
| Gain-bandwidth product          |  | 0.7     | 1                  |      | 0.7     | 1                  |      | MHz           |
| Supply-voltage rejection ratio  | $V_{CC} = 12\text{ V to }25\text{ V}$            | 60      | 70                 |      | 60      | 70                 |      | dB            |
| Output sink current             | VFB = 2.7 V, COMP = 1.1 V                        | 2       | 6                  |      | 2       | 6                  |      | mA            |
| Output source current           | VFB = 2.3 V, COMP = 5 V                          | -0.5    | -0.8               |      | -0.5    | -0.8               |      | mA            |
| High-level output voltage       | VFB = 2.3 V,<br>$R_L = 15\text{ k}\Omega$ to GND | 5       | 6                  |      | 5       | 6                  |      | V             |
| Low-level output voltage        | VFB = 2.7 V,<br>$R_L = 15\text{ k}\Omega$ to GND |         | 0.7                | 1.1  |         | 0.7                | 1.1  | V             |

(1) Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

(2) All typical values are at  $T_J = 25^\circ\text{C}$ .

## 5.8 Current-Sense Section Electrical Characteristics

$V_{CC} = 15\text{ V}^{(4)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER   | TEST CONDITIONS                       | TL284xB |                    |      | TL384xB |                    |      | UNIT          |
|---|---------------------------------------|---------|--------------------|------|---------|--------------------|------|---------------|
|   |                                       | MIN     | TYP <sup>(1)</sup> | MAX  | MIN     | TYP <sup>(1)</sup> | MAX  |               |
| Voltage amplification <sup>(2) (3)</sup>          |                                       | 2.85    | 3                  | 3.15 | 2.85    | 3                  | 3.15 | V/V           |
| Current-sense comparator threshold <sup>(2)</sup> | COMP = 5 V                            | 0.9     | 1                  | 1.1  | 0.9     | 1                  | 1.1  | V             |
| Supply-voltage rejection ratio <sup>(2)</sup>     | $V_{CC} = 12\text{ V to }25\text{ V}$ |         | 70                 |      |         | 70                 |      | dB            |
| Input bias current                                |                                       |         | -2                 | -10  |         | -2                 | -10  | $\mu\text{A}$ |
| Delay time to output                              | VFB = 0 V to 2 V                      |         | 150                | 300  |         | 150                | 300  | ns            |

(1) All typical values are at  $T_J = 25^\circ\text{C}$ .

(2) Measured at the trip point of the latch, with VFB at 0 V.

(3) Measured between  $I_{SENSE}$  and COMP, with the input changing from 0 V to 0.8 V.

(4) Adjust  $V_{CC}$  above the start threshold before setting  $V_{CC}$  to 15 V.

## 5.9 Output Section Electrical Characteristics

$V_{CC} = 15\text{ V}^{(2)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                 | TEST CONDITIONS                                | TL284xB |                    |     | TL384xB |                    |     | UNIT |
|---------------------------|--|---------|--------------------|-----|---------|--------------------|-----|------|
|                           |  | MIN     | TYP <sup>(1)</sup> | MAX | MIN     | TYP <sup>(1)</sup> | MAX |      |
| High-level output voltage | $I_{OH} = -20\text{ mA}$                       | 13      | 13.5               |     | 13      | 13.5               |     | V    |
|                           | $I_{OH} = -200\text{ mA}$                      | 12      | 13.5               |     | 12      | 13.5               |     |      |
| Low-level output voltage  | $I_{OL} = 20\text{ mA}$                        |         | 0.1                | 0.4 |         | 0.1                | 0.4 | V    |
|                           | $I_{OL} = 200\text{ mA}$                       |         | 1.5                | 2.2 |         | 1.5                | 2.2 |      |
| Rise time                 | $C_L = 1\text{ nF}$ , $T_J = 25^\circ\text{C}$ |         | 25                 | 150 |         | 25                 | 150 | ns   |
| Fall time                 | $C_L = 1\text{ nF}$ , $T_J = 25^\circ\text{C}$ |         | 25                 | 150 |         | 25                 | 150 | ns   |
| UVLO saturation           | $V_{CC} = 5\text{ V}$ , $I_{OL} = 1\text{ mA}$ |         | 0.7                | 1.2 |         | 0.7                | 1.2 | V    |

- (1) All typical values are at  $T_J = 25^\circ\text{C}$ .  
(2) Adjust  $V_{CC}$  above the start threshold before setting  $V_{CC}$  to 15 V.

## 5.10 Undervoltage-Lockout Section Electrical Characteristics

$V_{CC} = 15\text{ V}^{(2)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                                | TEST CONDITIONS  | TL284xB |                    |     | TL384xB |                    |      | UNIT |
|--|------------------|---------|--------------------|-----|---------|--------------------|------|------|
|  |                  | MIN     | TYP <sup>(1)</sup> | MAX | MIN     | TYP <sup>(1)</sup> | MAX  |      |
| Start threshold voltage                  | TLx842B, TLx844B | 15      | 16                 | 17  | 14.5    | 16                 | 17.5 | V    |
|  | TLx843B, TLx845B | 7.8     | 8.4                | 9   | 7.8     | 8.4                | 9    |      |
| Minimum operating voltage after start-up | TLx842B, TLx844B | 9       | 10                 | 11  | 8.5     | 10                 | 11.5 | V    |
|  | TLx843B, TLx845B | 7       | 7.6                | 8.2 | 7       | 7.6                | 8.2  |      |

- (1) All typical values are at  $T_J = 25^\circ\text{C}$ .  
(2) Adjust  $V_{CC}$  above the start threshold before setting  $V_{CC}$  to 15 V.

## 5.11 Pulse-Width Modulator Section Electrical Characteristics

$V_{CC} = 15\text{ V}^{(2)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER          | TEST CONDITIONS  | TL284xB |                    |     | TL384xB |                    |     | UNIT |
|--------------------|------------------|---------|--------------------|-----|---------|--------------------|-----|------|
|                    |                  | MIN     | TYP <sup>(1)</sup> | MAX | MIN     | TYP <sup>(1)</sup> | MAX |      |
| Maximum duty cycle | TLx842B, TLx843B | 92      | 96                 | 100 | 92      | 96                 | 100 | %    |
|                    | TLx844B, TLx845B | 46      | 48                 | 50  | 46      | 48                 | 50  |      |
| Minimum duty cycle |                  |         |                    | 0   |         |                    | 0   | %    |

- (1) All typical values are at  $T_J = 25^\circ\text{C}$ .  
(2) Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

## 5.12 Supply Voltage Electrical Characteristics

$V_{CC} = 15\text{ V}^{(2)}$ ,  $R_T = 10\text{ k}\Omega$ ,  $C_T = 3.3\text{ nF}$ , over recommended operating free-air temperature range (unless otherwise specified)

| PARAMETER                | TEST CONDITIONS            | TL284xB |                    |     | TL384xB |                    |     | UNIT |
|--------------------------|----------------------------|---------|--------------------|-----|---------|--------------------|-----|------|
|                          |                            | MIN     | TYP <sup>(1)</sup> | MAX | MIN     | TYP <sup>(1)</sup> | MAX |      |
| Start-up current         |                            |         | 0.3                | 0.5 |         | 0.3                | 0.5 | mA   |
| Operating supply current | VFB and $I_{SENSE}$ at 0 V |         | 11                 | 17  |         | 11                 | 17  | mA   |
| Limiting voltage         | $I_{CC} = 25\text{ mA}$    | 30      | 39                 |     | 30      | 39                 |     | V    |

- (1) All typical values are at  $T_J = 25^\circ\text{C}$ .  
(2) Adjust  $V_{CC}$  above the start threshold before setting it to 15 V.

### 5.13 Typical Characteristics

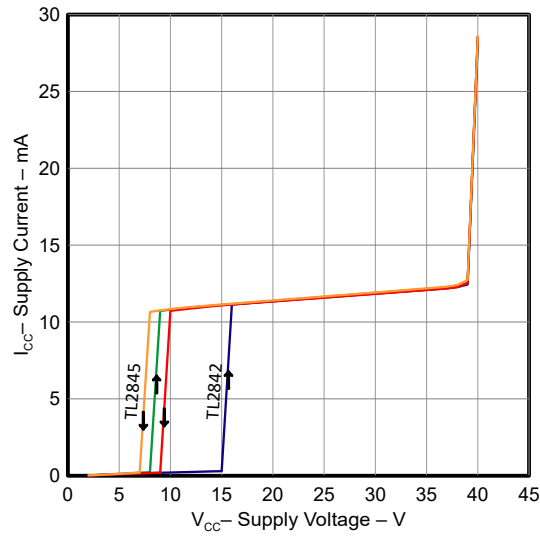


图 5-1. Supply Current vs Supply Voltage

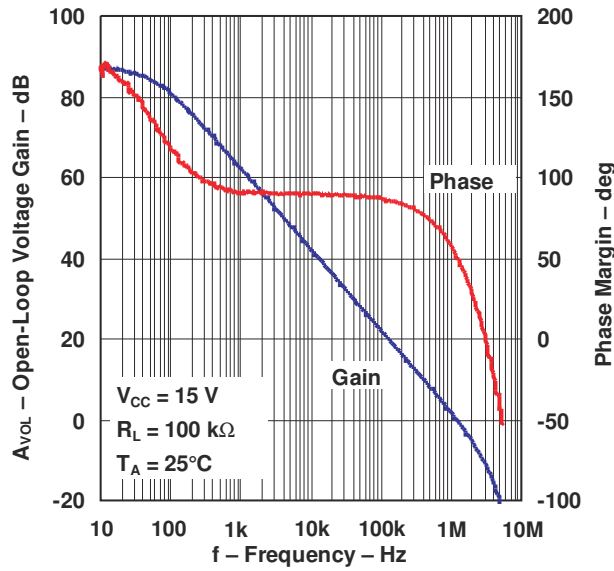


图 5-2. Error Amplifier Open-Loop Gain And Phase vs Frequency



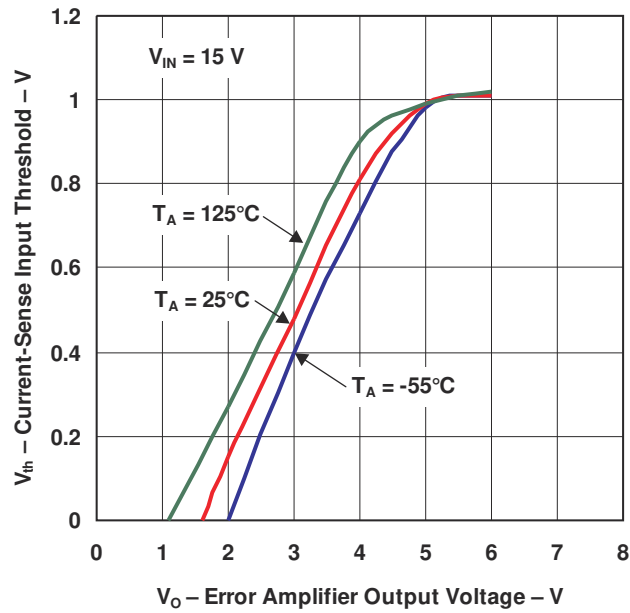


図 5-3. Current-Sense Input Threshold vs Error Amplifier Output Voltage

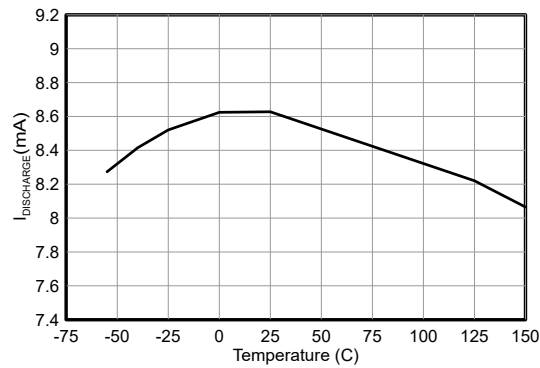


図 5-4. Oscillator Discharge Current vs Temperature

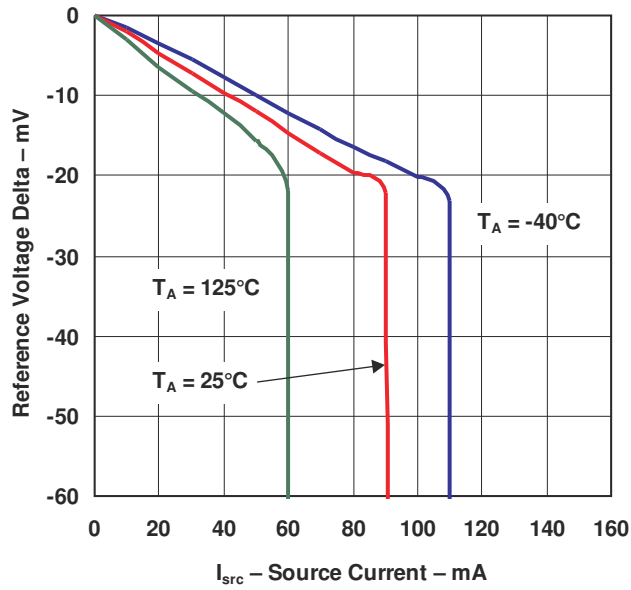


図 5-5. Reference Voltage vs Source Current

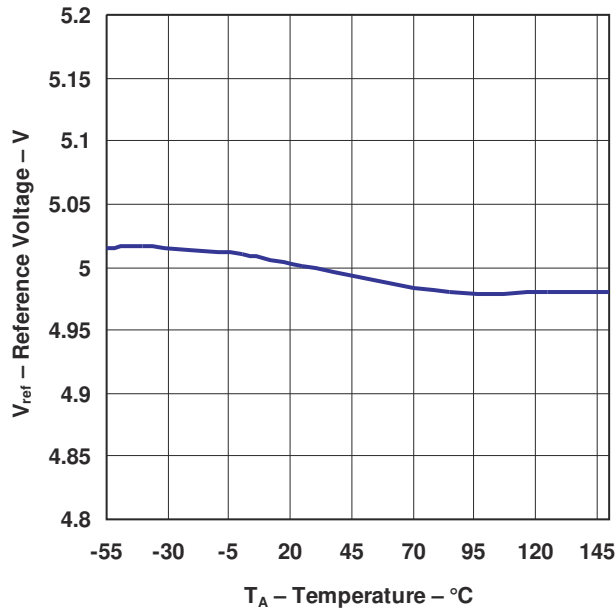
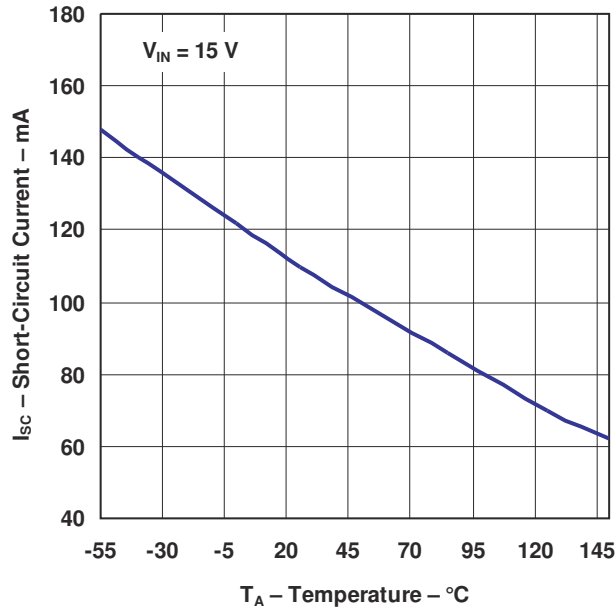
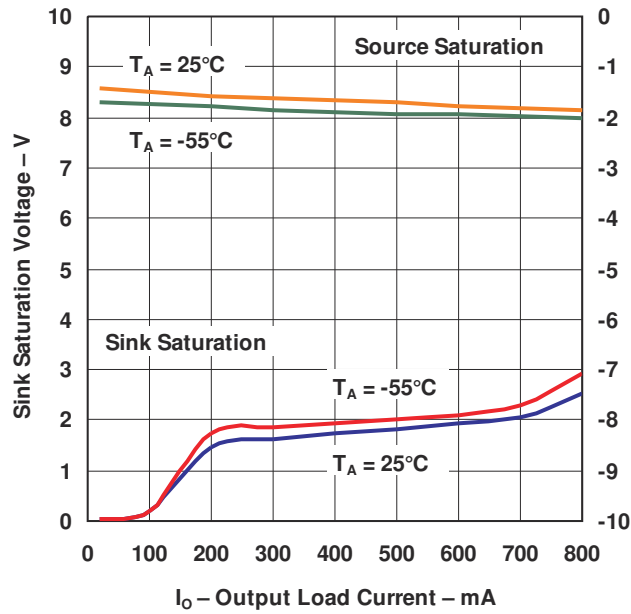


図 5-6. Reference Voltage vs Temperature




**5-7. Reference Short-Circuit Current vs Temperature**




**5-8. Output Saturation Voltage vs Load Current**

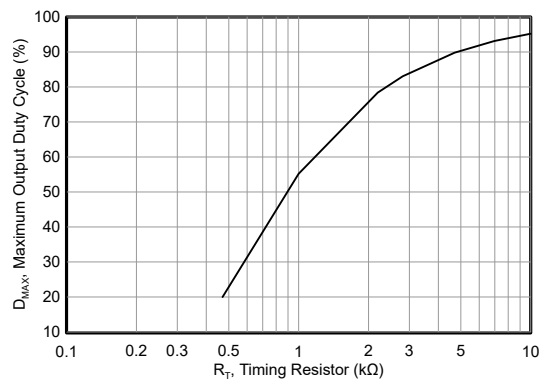
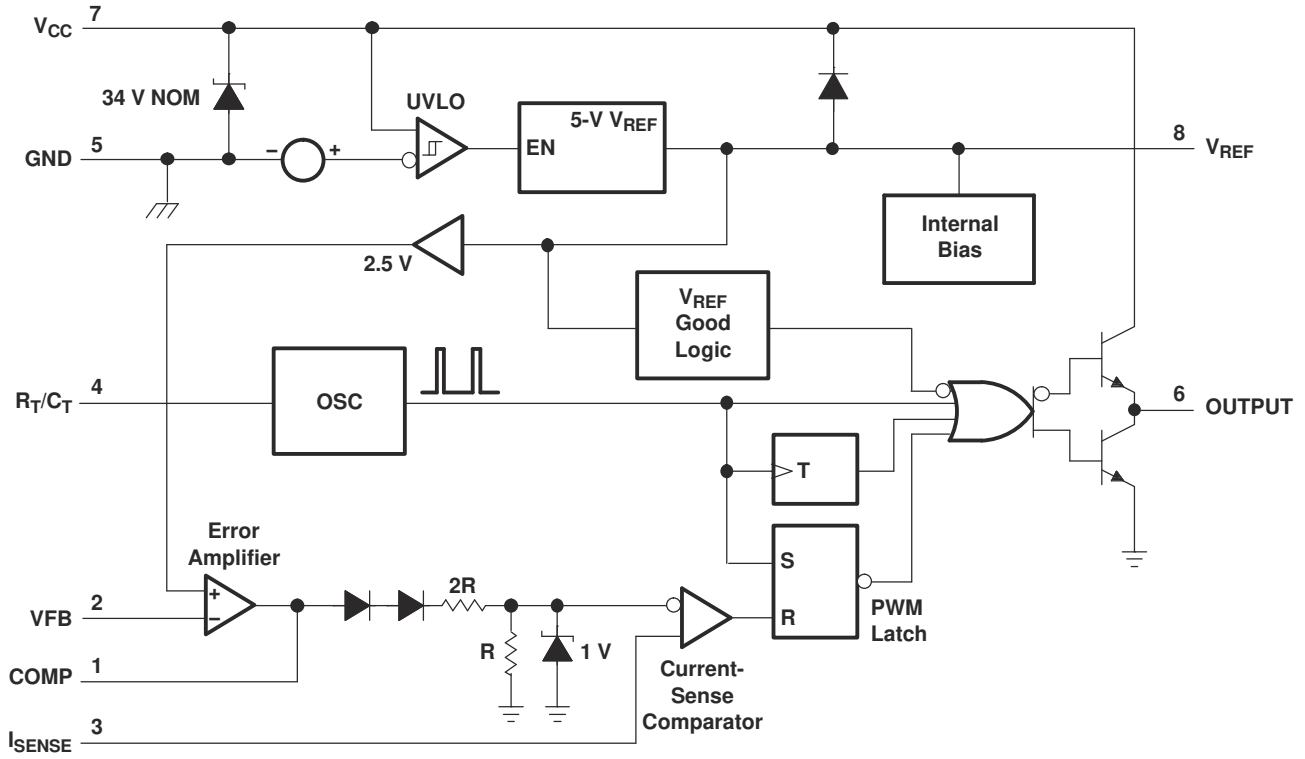


図 5-9. Maximum Output Duty Cycle vs Timing Resistor

## 6 Detailed Description

### 6.1 Functional Block Diagram



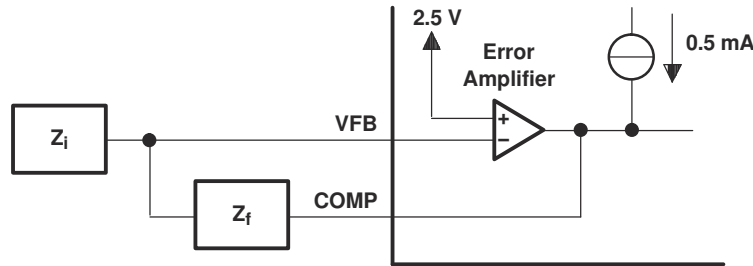
## 7 Application and Implementation

### 注

以下のアプリケーション情報は、TI の製品仕様に含まれるものではなく、TI ではその正確性または完全性を保証いたしません。個々の目的に対する製品の適合性については、お客様の責任で判断していただくこととなります。お客様は自身の設計実装を検証しテストすることで、システムの機能を確認する必要があります。

### 7.1 Application Information

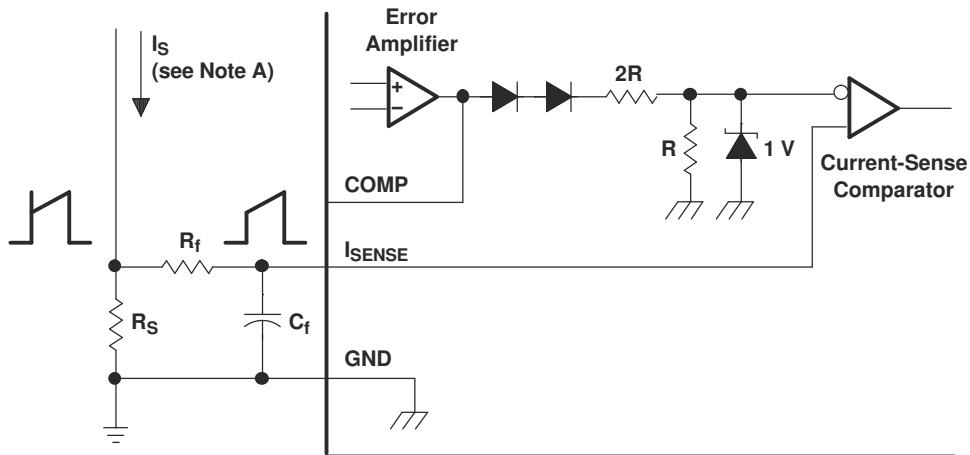
The error-amplifier configuration circuit is shown in [図 7-1](#).



A. Error amplifier can source or sink up to 0.5 mA.

**図 7-1. Error-Amplifier Configuration**

The current-sense circuit is shown in [図 7-2](#).



A. Peak current ( $I_S$ ) is determined by the formula:  $I_{S(max)} = 1 V/R_S$

B. A small RC filter formed by resistor  $R_f$  and capacitor  $C_f$  may be required to suppress switch transients.

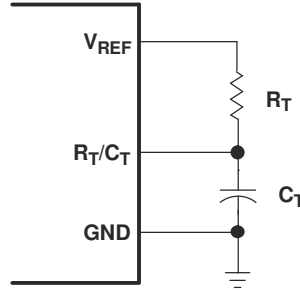
**図 7-2. Current-Sense Circuit**

The oscillator frequency is set using the circuit shown in [図 7-3](#). The frequency is calculated as:

$$f = 1 / R_T C_T$$

For  $R_T > 5 \text{ k}\Omega$ :

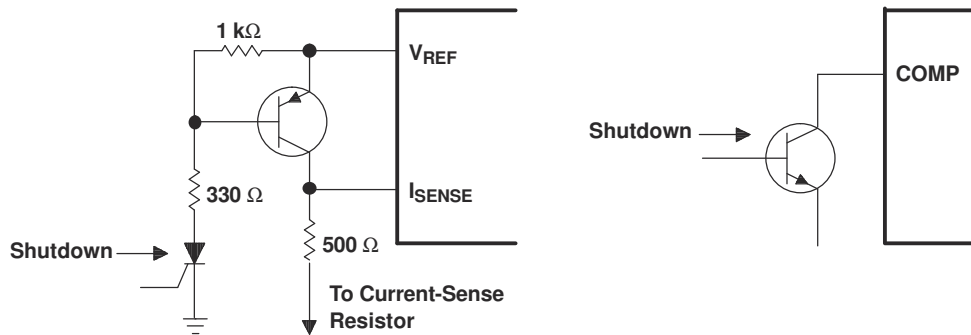
$$f \approx 1.72 / R_T C_T$$



7-3. Oscillator Section

## 7.2 Shutdown Technique

The PWM controller (see 7-4) can be shut down by two methods: either raise the voltage at  $I_{SENSE}$  above 1 V or pull the COMP terminal below a voltage two diode drops above ground. Either method causes the output of the PWM comparator to be high (refer to block diagram). The PWM latch is reset dominant so that the output remains low until the next clock cycle after the shutdown condition at the COMP or  $I_{SENSE}$  terminal is removed. In one example, an externally latched shutdown can be accomplished by adding an SCR that resets by cycling  $V_{CC}$  below the lower UVLO threshold. At this point, the reference turns off, allowing the SCR to reset.



7-4. Shutdown Techniques

A fraction of the oscillator ramp can be summed resistively with the current-sense signal to provide slope compensation for converters requiring duty cycles over 50% (see 7-5). Note that capacitor C forms a filter with R2 to suppress the leading-edge switch spikes.

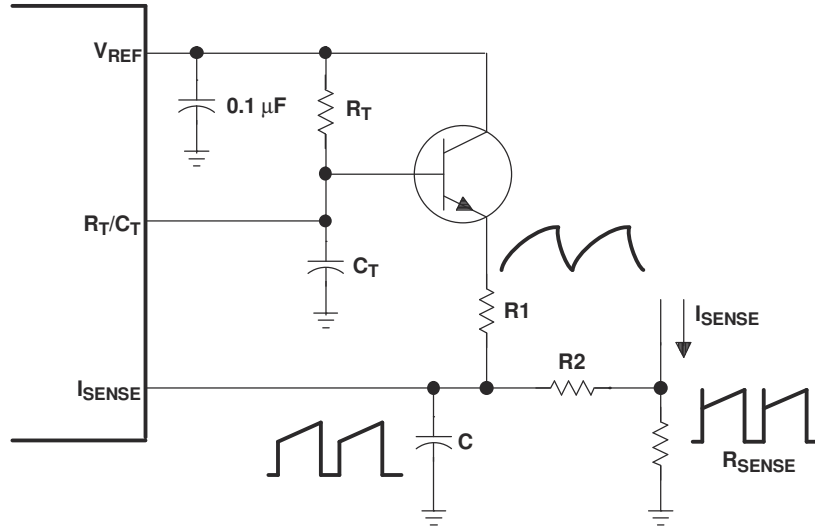


図 7-5. Slope Compensation

### 7.3 Open-Loop Laboratory Test Fixture

In the open-loop laboratory test fixture (see 図 7-6), high peak currents associated with loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to the GND terminal in a single-point ground. The transistor and 5-kΩ potentiometer sample the oscillator waveform and apply an adjustable ramp to the I<sub>SENSE</sub> terminal.

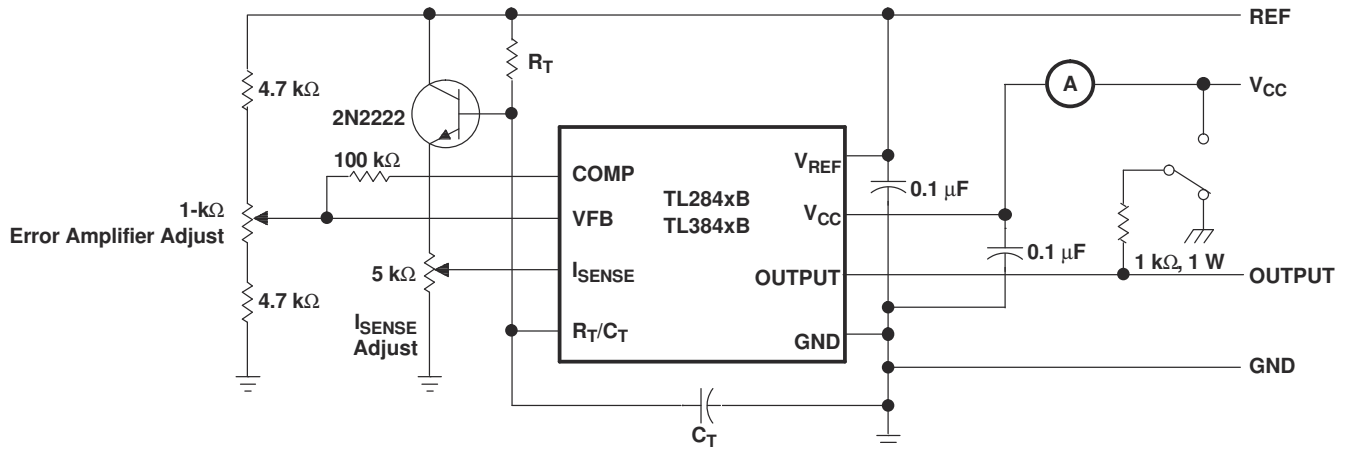
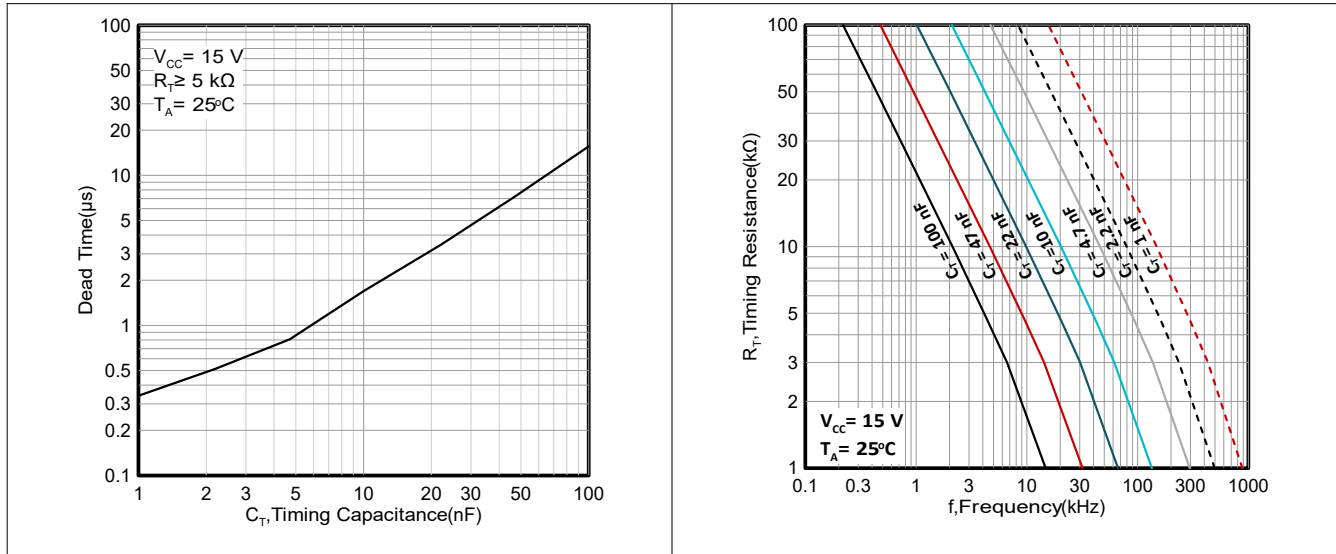


図 7-6. Open-Loop Laboratory Test Fixture

### 7.4 Typical Application



### 7.4.1 Application Curves



## 8 Device and Documentation Support

### 8.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

表 8-1. Related Links

| PARTS   | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|---------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| TL284xB | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| TL384xB | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 8.2 Trademarks

すべての商標は、それぞれの所有者に帰属します。

### 8.3 静電気放電に関する注意事項



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### 8.4 用語集

[テキサス・インスツルメンツ用語集](#)

この用語集には、用語や略語の一覧および定義が記載されています。

## 9 Revision History

### Changes from Revision B (July, 2007) to Revision C (October, 2024)

Page

- ドキュメント全体にわたって表、図、相互参照の採番方法を更新..... 1
- Changed ESD ratings, CDM rating from  $\pm 3000\text{V}$  to  $\pm 2000\text{V}$ ..... 4
- Changed thermal information for D-8, D-14, and P-8 packages..... 5
- Changed Electrical Char. table, TOTAL STANDBY CURRENT, VCC Zener voltage, typical value from 34V to 39V..... 5

|   |    |
|---|----|
| • Changed in Electrical Char. table, Oscillator Section: at $T_j=25^{\circ}\text{C}$ , min. value from 49kHz to 47kHz, max. value from 55kHz to 57kHz.....                  | 5  |
| • Changed in Electrical Char. table, Oscillator Section: at $T_A=T_{\text{low}}$ to $T_{\text{high}}$ , min. value from 48kHz to 44kHz, max. value from 56kHz to 60kHz..... | 5  |
| • Changed in Electrical Char. table, OUTPUT Section: Rise and fall time, typical value from 50ns to 25ns.....   | 7  |
| • Changed in Electrical Char. table, PWM: maximum duty cycle of TLx842/3B, minimum value from 94% to 92%.....   | 7  |
| • Changed in Electrical Char. table, PWM: maximum duty cycle of TLx844/5B, minimum value from 47% to 46%.....   | 7  |
| • Changed Part numbers edited.....  | 7  |
| • Updated the <i>Typical Characteristics</i> graphs for $I_{\text{discharge}}$ and $T_a$ , $I_{V_{\text{CC}}-V_{\text{CC}}}$ , and $D_{\text{max}}$ and $R_t$ .....         | 8  |
| • Updated Application Curves for $t_{\text{deadtime-Ct}}$ and $R_t\text{-f}$ .....  | 17 |

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## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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**PACKAGING INFORMATION**

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TL2842BD              | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | TL2842B             |
| TL2842BD-8            | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | 2842B               |
| TL2842BDR             | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2842B             |
| TL2842BDR-8           | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2842B               |
| TL2842BDR-8.A         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2842B               |
| TL2842BDR.A           | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2842B             |
| TL2842BP              | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TL2842BP            |
| TL2842BP.A            | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TL2842BP            |
| TL2843BD              | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | TL2843B             |
| TL2843BD-8            | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | 2843B               |
| TL2843BDR             | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2843B             |
| TL2843BDR-8           | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2843B               |
| TL2843BDR-8.A         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2843B               |
| TL2843BDR.A           | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2843B             |
| TL2843BDRG4-8         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2843B               |
| TL2843BP              | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TL2843BP            |
| TL2843BP.A            | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TL2843BP            |
| TL2844BD-8            | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | 2844B               |
| TL2844BDR             | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2844B             |
| TL2844BDR-8           | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2844B               |
| TL2844BDR-8.A         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2844B               |
| TL2844BDR.A           | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2844B             |
| TL2844BDRG4-8         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2844B               |
| TL2845BD              | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | TL2845B             |
| TL2845BD-8            | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | 2845B               |
| TL2845BDR             | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2845B             |
| TL2845BDR-8           | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2845B               |
| TL2845BDR-8.A         | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2845B               |
| TL2845BDR.A           | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TL2845B             |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TL2845BDRG4-8               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 2845B               |
| <a href="#">TL3842BD</a>    | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | TL3842B             |
| <a href="#">TL3842BD-8</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3842B               |
| <a href="#">TL3842BDR</a>   | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3842B             |
| <a href="#">TL3842BDR-8</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3842B               |
| TL3842BDR-8.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3842B               |
| TL3842BDR.A                 | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3842B             |
| <a href="#">TL3842BP</a>    | Obsolete      | Production           | PDIP (P)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | TL3842BP            |
| <a href="#">TL3843BD</a>    | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | TL3843B             |
| <a href="#">TL3843BD-8</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3843B               |
| <a href="#">TL3843BDR</a>   | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3843B             |
| <a href="#">TL3843BDR-8</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3843B               |
| TL3843BDR-8.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3843B               |
| TL3843BDR.A                 | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3843B             |
| <a href="#">TL3843BP</a>    | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3843BP            |
| TL3843BP.A                  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3843BP            |
| <a href="#">TL3844BD-8</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3844B               |
| <a href="#">TL3844BDR</a>   | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3844B             |
| <a href="#">TL3844BDR-8</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3844B               |
| TL3844BDR-8.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3844B               |
| TL3844BDR.A                 | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TL3844B             |
| <a href="#">TL3844BP</a>    | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3844BP            |
| TL3844BP.A                  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3844BP            |
| <a href="#">TL3845BD</a>    | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | TL3845B             |
| <a href="#">TL3845BD-8</a>  | Obsolete      | Production           | SOIC (D)   8   | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | 3845B               |
| <a href="#">TL3845BDR</a>   | Obsolete      | Production           | SOIC (D)   14  | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | TL3845B             |
| <a href="#">TL3845BDR-8</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3845B               |
| TL3845BDR-8.A               | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 3845B               |
| <a href="#">TL3845BP</a>    | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3845BP            |
| TL3845BP.A                  | Active        | Production           | PDIP (P)   8   | 50   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TL3845BP            |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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#### OTHER QUALIFIED VERSIONS OF TL2843B :

- Automotive : [TL2843B-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL2842BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL2842BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL2843BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL2843BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL2844BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL2844BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL2845BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL2845BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3842BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL3842BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3843BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL3843BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3844BDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TL3844BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TL3845BDR-8 | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL2842BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL2842BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL2843BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL2843BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL2844BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL2844BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL2845BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL2845BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL3842BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL3842BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL3843BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL3843BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL3844BDR   | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| TL3844BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| TL3845BDR-8 | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |



**TUBE**


\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TL2842BP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL2842BP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL2843BP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL2843BP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3843BP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3843BP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3844BP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3844BP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3845BP   | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TL3845BP.A | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |



# D0014A

# PACKAGE OUTLINE

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

### NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



D0008A

# PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
 EXPOSED METAL SHOWN  
 SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



4040082/E 04/2010

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.



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